

## Company Overview Corporate Fact Sheet

Market leader in the high-end power chip market (SiC and 300mm Si HTR) and in developing and supplying essential equipment and consumables used in the semiconductor industry.

**Amtech Systems, Inc.** is a leading, global manufacturer of capital equipment, including thermal processing and wafer polishing, and related consumables used in fabricating semiconductor devices, such as silicon carbide (SiC) and silicon power devices, analog and discrete devices, electronic assemblies and light-emitting diodes (LEDs). We sell these products to semiconductor device and module manufacturers worldwide, particularly in Asia, North America and Europe. Our strategic focus is on semiconductor growth opportunities in power electronics, sensors and analog devices leveraging our strength in our core competencies in thermal and substrate processing. We are a market leader in the high-end power chip market (SiC substrates, 300mm horizontal thermal reactor, and electronic assemblies used in power, RF, and other advanced applications), developing and supplying essential equipment and consumables used in the semiconductor industry. Amtech's products are recognized under the leading brand names BTU International, Bruce Technologies™, and PR Hoffman™.

Focused on manufacturing innovation in two end markets:

- **Semiconductors and Electronics:** equipment used in key thermal processes for packaging and assembling chips
  - Successful development of new generation reflow equipment/technologies
  - Successful development of 300mm Analog/Power Chip diffusion furnace
- **SiC/LEDs:** SiC/GaN, Si, LED Sapphire lapping and polishing consumables and machines

On March 28, 2019, the Company adopted a plan to sell the majority of the Solar segment to include Tempress and SoLayTec. As a result, the Company was reporting those subsidiaries as discontinued operations beginning with its results from second quarter of fiscal year 2019. The Company completed the sale of its solar subsidiaries, SoLayTec and Tempress, on June 7, 2019, and January 22, 2020, respectively. Additionally, on December 13, 2019, the Company completed the sale of its automation division, R2D.

### Company Information *(As of September 30, 2020)*

Headquarters	Tempe, AZ
Founded	1981
Number of Employees	296
Manufacturing	U.S. and China
Sales & Support	Global

### Stock Information *(As of September 30, 2020)*

Last Trade	\$4.89
52-week Price Range	\$3.55 – 7.96
Shares Outstanding	14,063,172
Market Capitalization	\$68.8M
Average Daily volume (3 mos.)	50,512
Fiscal Year End	September 30

### Fourth Quarter Highlights

- Revenue in the fourth quarter of FY2020 of \$15.1 million
- Operating loss of \$1.2 million
- Loss from continuing operations, net of tax, of \$2.0 million
- Customer orders of \$13.8 million
- Backlog of \$13.9 million
- Unrestricted cash of \$45.1 million
- Received a repeat order of our 300mm clustered HTR diffusion furnace from a top-tier global power semiconductor customer

### Financials

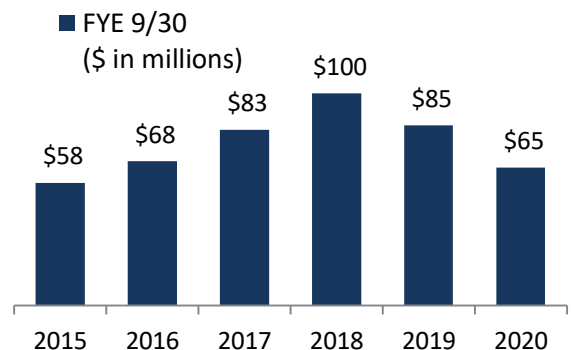
*(In thousands except per share data)*


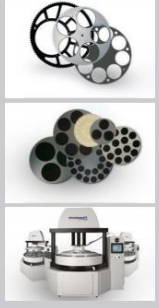





Statement of Operations	Quarter Ended September 30,	
	2020	2019
Net revenue	\$15,084	\$20,174
Gross margin	33%	42%
Net (loss) income	(\$2,025)	\$798
EPS diluted	(\$0.14)	\$0.06
Wtd shares o/s-diluted	14,052	14,304

Balance Sheet	9/30/2020	9/30/2019
	Cash and cash equivalents	\$45,070
Total Debt	\$5,178	\$5,549
Shareholders' Equity	\$81,519	\$87,452

### Annual Revenue



<b>AMTECH</b> GROUP 	<b>Chip Substrate</b>	<b>Chip Fabrication</b>	<b>Chip Packaging and SMT</b>
<b>Value Chain</b>			
<b>Brand</b>	<b>PR HOFFMAN</b> AMTECH GROUP 	<b>BRUCE</b> AMTECH GROUP 	<b>BTU International</b> AMTECH GROUP 
<b>Business Strategy</b>	Emerging Growth	Growth	Core Foundation
<b>Main Products</b>	Substrate lapping and polishing consumables and machines	Horizontal thermal diffusion & CVD furnaces	Advanced thermal processing equipment
<b>Key Customers</b>	Major SiC, Si, and sapphire wafer producers	Top players in power chip, sensor, and analog sectors	Chip packaging, SMT, and custom engineered high temperature belt furnace producer

*Strategic Acquisitions*

**ATMOSCAN**  
*(from Intel)*

**PR HOFFMAN**  
AMTECH GROUP 

**R2D**  
AMTECH GROUP 

**BTU International**  
AMTECH GROUP 

**TEMPRESS**  
AMTECH GROUP 

**BRUCE**  
AMTECH GROUP 

**Semiconductor KINGSTONE**

1983

1994

1996

2004

2007

2010

2015



**Investor Relations Contacts**

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